



NPN Power Silicon Transistor

Qualified per MIL-PRF-19500/315

Qualified Levels:
JAN, JANTX, and
JANTXV

DESCRIPTION

This NPN silicon transistor is rated at 5 amps and is military qualified up to a JANTXV level. This TO-59 isolated package features a 180 degree lead orientation.

Important: For the latest information, visit our website <http://www.microsemi.com>.

FEATURES

- JEDEC registered 2N2880
- Low saturation voltage
- Low leakage current
- Fast switching capable - 0.5 μ s rise time
- High frequency response
- TO-59 case with isolated terminals
- JAN, JANTX, and JANTXV, qualifications are available per MIL-PRF-19500/315
- RoHS compliant versions available (commercial grade only)

APPLICATIONS / BENEFITS

- Class 3B to ESD per MIL-STD-750 Method 1020
- High frequency inverters
- Converters
- Linear amplifiers
- High speed switching regulated power supplies
- RF power supplies

MAXIMUM RATINGS

Parameters/Test Conditions	Symbol	Value	Unit
Junction and Storage Temperature	T _J and T _{STG}	-65 to +200	°C
Thermal Resistance Junction-to-Case	R _{ΘJC}	3.33	°C/W
Collector Current	I _C	5.0	A
Collector-Emitter Voltage	V _{CEO}	80	V
Collector-Base Voltage	V _{CBO}	110	V
Emitter-Base Voltage	V _{EBO}	8.0	V
Total Power Dissipation	P _T	@ T _A = +25°C ⁽¹⁾	2.0
		@ T _C = +100°C ⁽²⁾	30

Notes:

1. Derate linearly 11.4 mW/ $^{\circ}\text{C}$ for $T_A > +25^{\circ}\text{C}$.
2. Derate linearly 300 mW/ $^{\circ}\text{C}$ for $T_C > +100^{\circ}\text{C}$.



Marking may vary.

TO-59 Package

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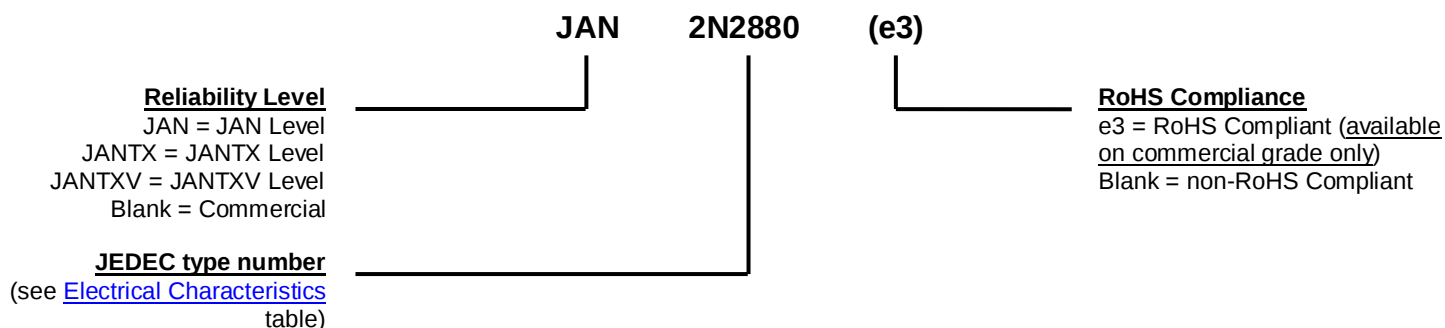
Website:

www.microsemi.com

MECHANICAL and PACKAGING

- CASE: Nickel Plated
- TERMINALS: Solder Dip over Nickel Plating. RoHS compliant Matte/Tin available on commercial grade only.
- MARKING: Manufacturer's ID, Date Code, Part Number, BeO
- POLARITY: See Package Outline Drawing on last page
- WEIGHT: Approximately 4.576 grams
- See [Package Dimensions](#) on last page.

PART NOMENCLATURE



SYMBOLS & DEFINITIONS

Symbol	Definition
I_B	Base current: The value of the dc current into the base terminal.
I_C	Collector current: The value of the dc current into the collector terminal.
I_E	Emitter current: The value of the dc current into the emitter terminal.
P_T	Total power dissipation: The sum of the forward and reverse power dissipations.
V_{BE}	Base-emitter voltage: The dc voltage between the base and the emitter.
V_{CE}	Collector-emitter voltage: The dc voltage between the collector and the emitter.
V_{CEO}	Collector-emitter voltage, base open: The voltage between the collector and the emitter terminals when the base terminal is open-circuited.
V_{CB}	Collector-base voltage: The dc voltage between the collector and the base.
V_{CBO}	Collector-base voltage, base open: The voltage between the collector and base terminals when the emitter terminal is open-circuited.
V_{EB}	Emitter-base voltage: The dc voltage between the emitter and the base
V_{EBO}	Emitter-base voltage, collector open: The voltage between the emitter and base terminals with the collector terminal open-circuited.

ELECTRICAL CHARACTERISTICS @ $T_C = 25^\circ\text{C}$ unless otherwise noted

Characteristic	Symbol	Min.	Max.	Unit
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OFF CHARACTERISTICS

Collector-Emitter Breakdown Voltage $I_C = 100\text{ mA}$	$V_{(BR)CEO}$	80		V
Collector-Emitter Breakdown Voltage $I_C = 10\text{ }\mu\text{A}$	$V_{(BR)CBO}$	110		V
Emitter-Base Breakdown to Voltage $I_E = 10\text{ }\mu\text{A}$	$V_{(BR)EBO}$	8.0		V
Collector-Emitter Cutoff Current $V_{CE} = 60\text{ V}$	I_{CEO}		20	μA
Collector-Base Cutoff Current $V_{CB} = 80\text{ V}$	I_{CBO}		0.2	μA
Collector-Emitter Cutoff Current $V_{CE} = 110\text{ V}, V_{BE} = -0.5$	I_{CEX}		1.0	μA
Emitter-Base Cutoff Current $V_{EB} = 6.0\text{ V}$	I_{EBO}		0.2	μA

ON CHARACTERISTICS

Forward-Current Transfer Ratio $I_C = 50\text{ mA}, V_{CE} = 5.0\text{ V}$ $I_C = 1.0\text{ A}, V_{CE} = 2.0\text{ V}$ $I_C = 5.0\text{ A}, V_{CE} = 5.0\text{ V}$	h_{FE}	40 40 15	120 120	
Base-Emitter Voltage Non-saturated $V_{CE} = 2.0\text{ V}, I_C = 1.0\text{ A}$	V_{BE}		1.2	V
Collector-Emitter Saturation Voltage $I_C = 1.0\text{ A}, I_B = 0.1\text{ A}$ $I_C = 5.0\text{ A}, I_B = 0.5\text{ A}$	$V_{CE(sat)}$		0.25 1.5	V
Base-Emitter Saturation Voltage $I_C = 1.0\text{ A}, I_B = 0.1\text{ A}$	$V_{BE(sat)}$		1.2	V

DYNAMIC CHARACTERISTICS

Magnitude of Common Emitter Small-Signal Short-Circuit Forward Current Transfer Ratio $I_C = 1.0\text{ A}, V_{CE} = 10.0\text{ V}, f = 10\text{ MHz}$	$ h_{fe} $	3.0	12	
Common Emitter Small-Signal Short-Circuit Forward Current Transfer Ratio $I_C = 50\text{ mA}, V_{CE} = 5.0\text{ V}, f = 1\text{ kHz}$	h_{fe}	40	140	
Output Capacitance $V_{CB} = 10\text{ V}, I_E = 0, 100 \leq f \leq 1.0\text{ MHz}$	C_{obo}		150	pF

SWITCHING CHARACTERISTICS

Pulse delay time	t_d		60	ns
Pulse rise time	t_r		300	ns
Pulse storage time	t_s		1.7	μs
Pulse fall time	t_f		300	ns

ELECTRICAL CHARACTERISTICS @ $T_C = 25^\circ\text{C}$ unless otherwise noted. (continued)
SAFE OPERATING AREA (See Figure below and [MIL-STD-750, Test Method 3053](#))
DC Tests
 $T_C = +100^\circ\text{C}$, $t = 10$ seconds

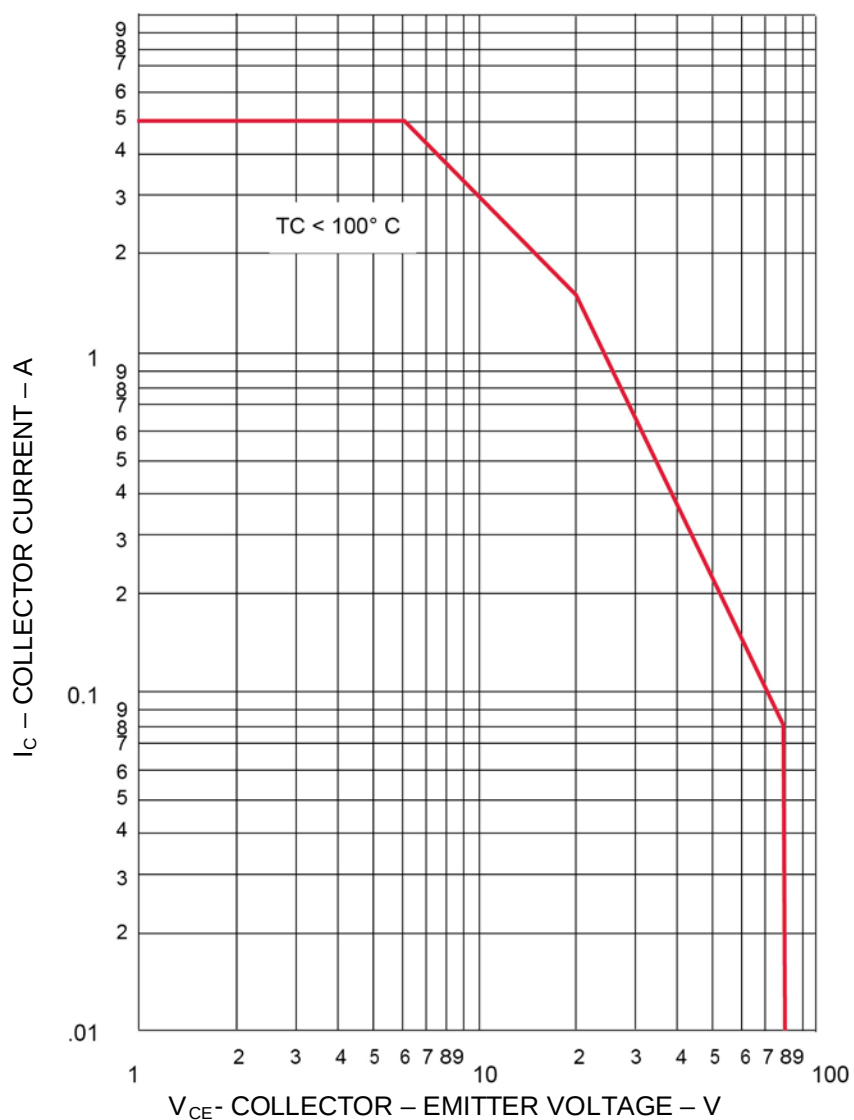
Test 1
 $V_{CE} = 80\text{ V}$, $I_C = 80\text{ mA}$
Test 2
 $V_{CE} = 20\text{ V}$, $I_C = 1.5\text{ A}$


FIGURE 1
Maximum Safe Operating Area

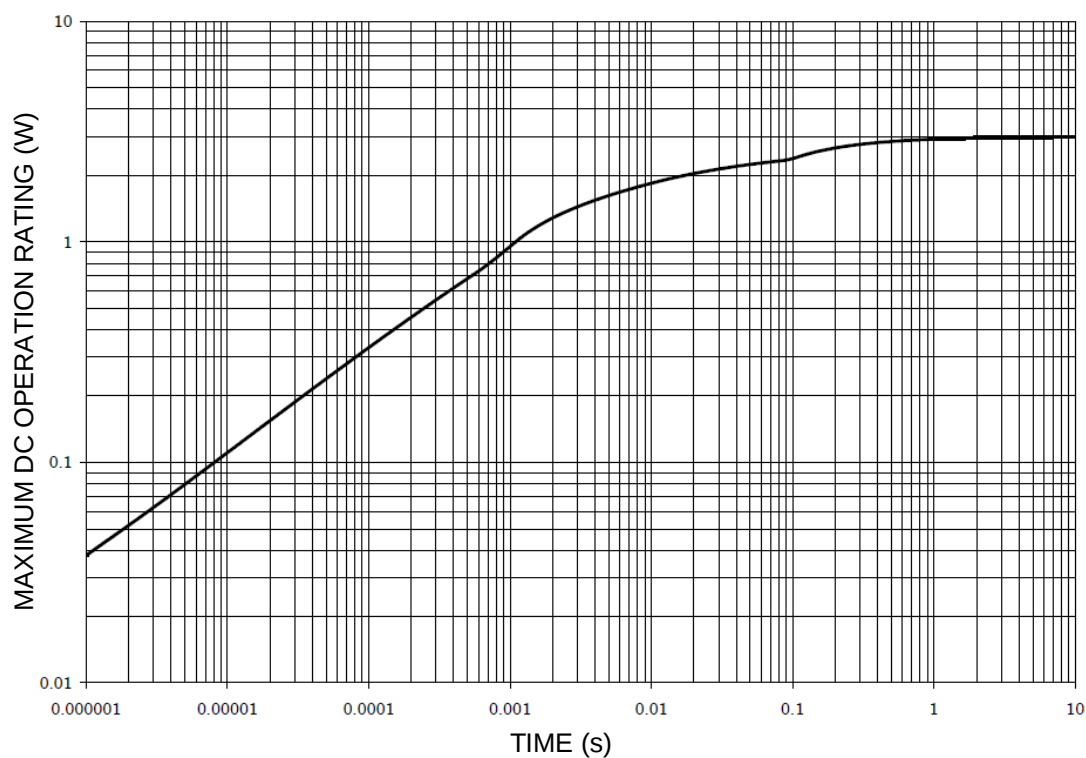
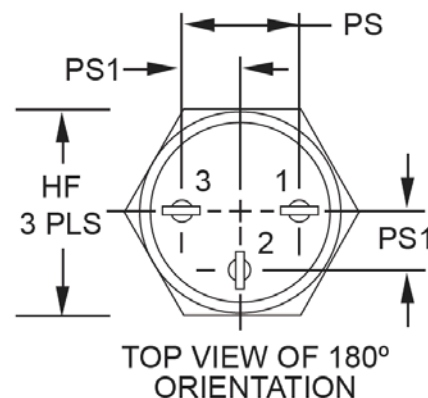
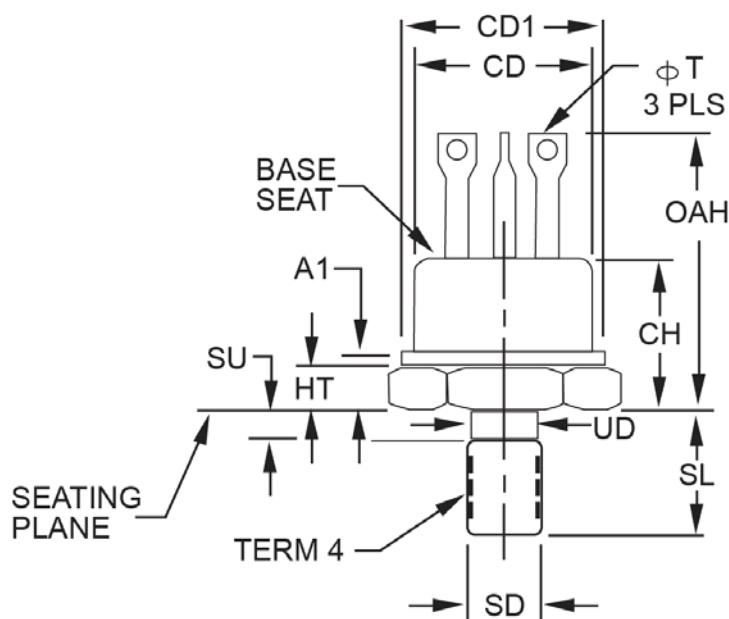
GRAPHS


FIGURE 2
Thermal Impedance

PACKAGE DIMENSIONS

NOTES:

1. Dimensions are in inches.
2. Millimeters are given for information only.
3. Collector shall be electrically connected to the case. This terminal may be flattened and pierced only when the 90 degree option is used.
4. SD is the outer diameter of coated threads. (Reference: Screw thread standards for Federal Standard H28/1, (FED-STD-H28/1).
5. The orientation of the terminals in relation to the hex flats is not controlled.
6. All three terminals.
7. The case temperature may be measured anywhere on the seating plane within .125 (3.18 mm) of the stud.
8. Terminal spacing measured at the base seat only.
9. Dimensions e, e1, PS1, and PS are measured from the center line of terminals.
10. Maximum unthreaded dimension.
11. This dimension applies to the location of the center line of the terminals.
12. A 90 degree angle lead orientation as shown may be used at the option of the manufacturer. All dimensions of the basic outline except e, e1, and the 120 degree lead angle apply to this option.

Symbol	Dimension				Notes
	Inch		Millimeters		
	Min	Max	Min	Max	
A1	0.090	0.150	2.29	3.81	
CD	0.320	0.468	8.13	11.89	
CD1	0.380	0.437	9.65	11.10	
CH	0.320	0.468	8.13	11.89	
HF	0.423	0.438	10.74	11.13	
HT	-	0.250	-	6.35	
OAH	0.570	0.763	14.48	19.38	4
PS	0.185	0.215	4.70	5.46	5, 8, 9
PS1	0.090	0.110	2.29	2.79	5, 8, 9
SD	0.190-32UNF-2A				4
SL	0.400	0.455	10.16	11.56	
SU	-	0.078	-	1.98	10
ϕT	0.040	0.065	1.02	1.65	
UD	0.155	0.189	3.94	4.80	

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